#### 1.6x0.8mm INFRARED EMITTING DIODE

Part Number: APT1608SF4C-PRV

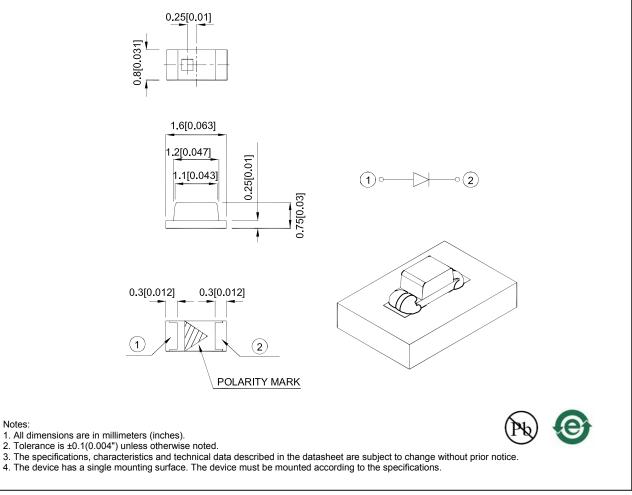
#### Features

- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Mechanically and spectrally matched to phototransistor.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes.

#### **Package Dimensions**



REV NO: V.4B CHECKED: Allen Liu DATE: MAR/18/2015 DRAWN: P.Cheng PAGE: 1 OF 5 ERP: 1203008849

#### Selection Guide

Selection Guide					
Part No. Dice		Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APT1608SF4C-PRV	SF4 (GaAlAs)	Water Clear	0.8	1.5	120°

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Radiant Intensity/ luminous flux: +/-15%.

3. Radiant intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	SF4	VF	1.3	1.6	V	I⊧=20mA	
Reverse Current	SF4	lr		10	uA	VR = 5V	
Capacitance	SF4	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	SF4	λP	880		nm	I⊧=20mA	
Spectral Bandwidth	SF4	Δλ1/2	50		nm	I⊧=20mA	

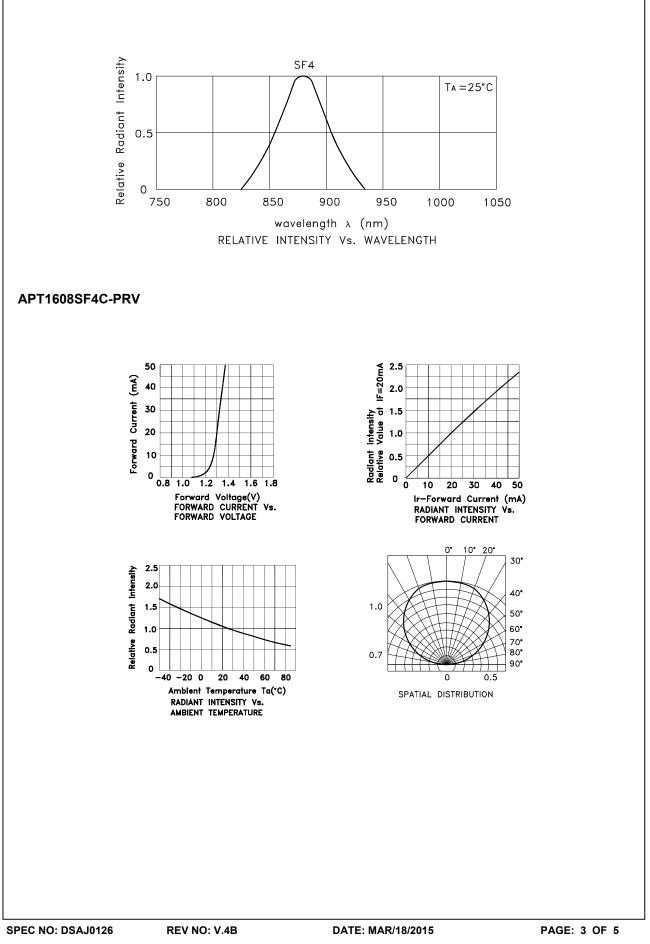
Notes:

Forward Voltage: +/-0.1V.
Wavelength value is traceable to the CIE127-2007 compliant national standards.
Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	SF4	Units
Power dissipation	Po	80	mW
DC Forward Current	lf	50	mA
Peak Forward Current [1]	İFS	1.2	A
Reverse Voltage	VR	5	V
Operating Temperature	Та	-40 To +85	°C
Storage Temperature	Тятд	-40 To +85	°C

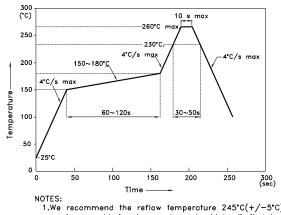
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.



### APT1608SF4C-PRV

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.





 We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

3.Number of reflow process shall be 2 times or less.

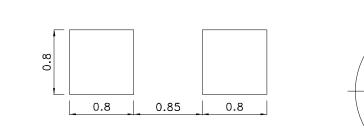


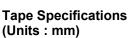
### **Reel Dimension**

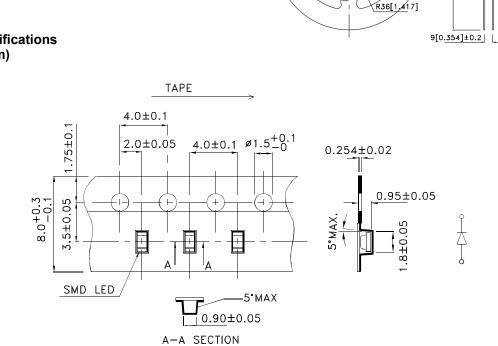
1<u>8[.70</u>9]±0.2

õ

R6.5[.256]±

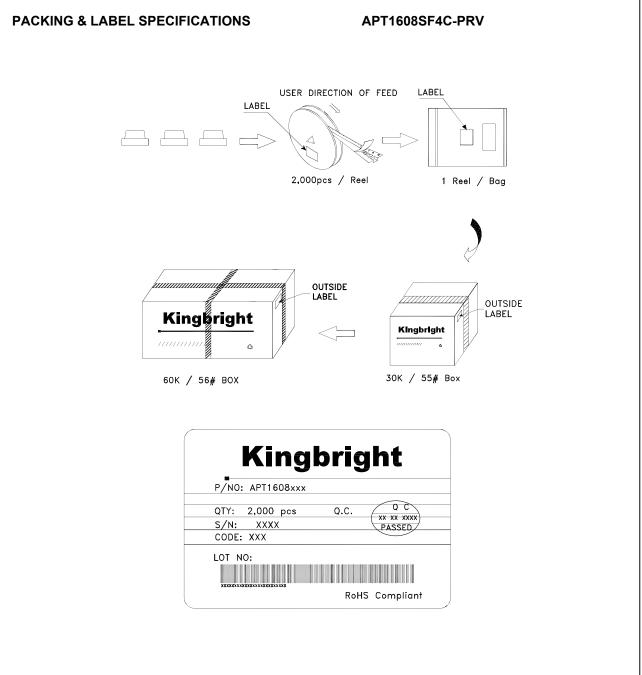






12[0.472]±0.5

ø178[7.008]±1 ø60[2.362] ø56[2.205]



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DATE: MAR/18/2015 DRAWN: P.Cheng